ABSOCIATION CONNECTING ELECTRONICS INDUSTRIES® International and Pa	IPC, Bannock	burn, Illinois. A	Il rights reserved u ntions.	nder both	This docume level parts, t	ent is a decla the declaratio	ration on enco	of the substa mpasses all	ances w lower l	ithin the manufa evel materials fo	cturer listed or which the	item. N manufa	Note: if th acturer ha	ne item is an as as engineering	sembly with low responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					aterials and N	ials and Mfg Information					
Supplier Information																
Company name*			Company unique ID			Unique ID Authority					Respor	Response Date*				
nsemi											2024-04	2024-04-29				
Contact Name Title - Contact					Phone - Contact*					Email ·	Email - Contact*					
Product-Env-Stewards Product Enviro Comp				iance			NA					Product-Env-Stewards@onsemi.com				
uthorized Representative* Title - Representative			sentative	Phone - R			Representative* Er			Email ·	Email - Representative*					
Product-Env-Stewards	Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com						
Requester Item Number	Mfr Iten	n Number				Effective D	ate V	/ersion	Ma	Manufacturing Site		Weight*		UOM	Unit Type	
	FDMS7	620S-F106				2024-04-29		, ,		TH2		72.46895		mg	Each	
Ianufacturing Proccess Informa	ation									_				1	I	
Terminal Plating / Grid Array M	laterial '	Ferminal Base	Alloy	J-STD-020 MSL Rating		Peak Process		Body Temperature Max Time at Peak		eak Tempera	Temperature Number		of Reflow Cyc	les		
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		CU Alloy 1		1		260		С		30		nds	3			
comments																
vel 1 - maximum time at peak temperat	ure during so	dering is 10-3	0 seconds													
or more information regarding materia	l composition	please refer to	page 3													

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.0142	mg	Supplier	Silicon (Si)	7440-21-3		1.0142	mg
Die Attach	0.1306	mg	Supplier	Isobornyl Methacrylate	7534-94-3		0.0078	mg
			Supplier	Silver (Ag)	7440-22-4		0.1064	mg
			Supplier	Isobornyl Acrylate	5888-33-5		0.0078	mg
			Supplier	Misc.	Proprietary Data		0.0007	mg
			Supplier	Tricyclo[5.2.1.02,6]decanedimethanol Diacrylate (C18H24O4)	42594-17-2		0.0078	mg
Lead Frame	33.5385	mg	Supplier	Zinc (Zn)	7440-66-6		0.0436	mg
			Supplier	Iron (Fe)	7439-89-6		0.7882	mg
			Supplier	Copper (Cu)	7440-50-8		32.6799	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0268	mg
Mold Compound-Black	36.8372	mg	Supplier	Carbon Black (C)	1333-86-4		0.1842	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		32.4167	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		2.3944	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		1.8419	mg
Plating	0.0073	mg	Supplier	Silver (Ag)	7440-22-4		0.0073	mg
Plating NiPdAu	0.4613	mg	Supplier	Palladium (Pd)	7440-05-3		0.0231	mg
			В	Nickel (Ni)	7440-02-0		0.4152	mg
			Supplier	Gold (Au)	7440-57-5		0.0231	mg
Wire Bond - Cu	0.47985	mg	Supplier	Copper (Cu)	7440-50-8		0.4798	mg